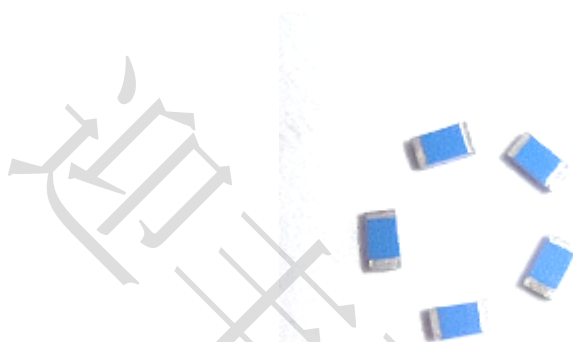


1.6X0.8X0.5 (mm) WiFi/Bluetooth Ceramic Chip Antenna (YF1608H1) Engineering Specification

1. Product Number

YF	1608	H1	P	2G45
1	2	3	4	5



2. Features

(1)Product Type	Chip Antenna
(2)Size Code	1.6x0.8x0.5mm
(3)Type Code	H1
(4)Packing	Paper &Reel
(5)Frequency	2.45GHz



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGYCO.,LTD

Prepared by : **JIEXI**

Designed by : **Jason**

Checked by : **Jason**

Approved by : **MR.FANG**

**TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification**

**DOCUMENT
NO.**

YF1608H1P2G45

**REV.
A**

- *Stable and reliable in performances
- *Low temperature coefficient of frequency
- *Low profile, compact size
- *RoHS compliance
- *SMT processes compatible

3. Applications

- *Bluetooth earphone systems
- *Hand-held devices when WiFi /Bluetooth functions are needed, e.g., Smart phone.
- *IEEE802.11 b/g/n
- *ZigBee
- *Wireless PCMCIA cards or USB dongle

4. Description

Yingfeng chip antenna series are specially designed for WiFi/Bluetooth applications. Based on yingfeng proprietary design and processes, this chip antenna has excellent stability and sensitivity to consistently provide high signal reception efficiency.

5. Electrical Specifications (40 x 40 mm² ground plane)

5-1. Electrical Table

Characteristics		Specifications	Unit
Outline Dimensions		1.6x0.8x0.5	mm
Working Frequency		2400~2500	MHz
VSWR		2 Max.	
Impedance		50	Ω
Polarization		Linear Polarization	
Gain	Peak	1.5 (typical)	dBi
	Efficiency	65 (typical)	%



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

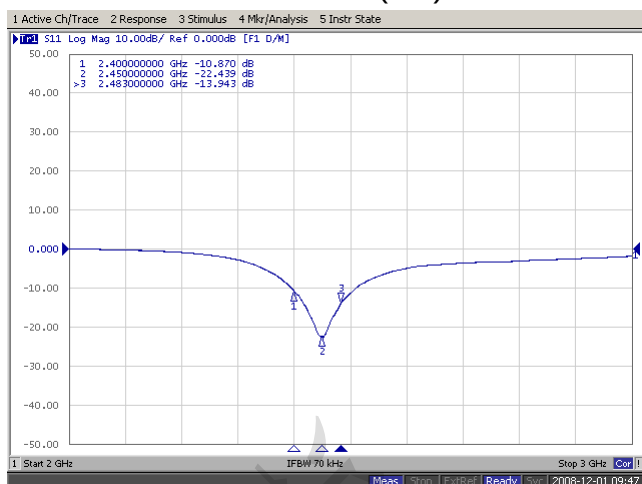
DOCUMENT
NO.

YF1608H1P2G45

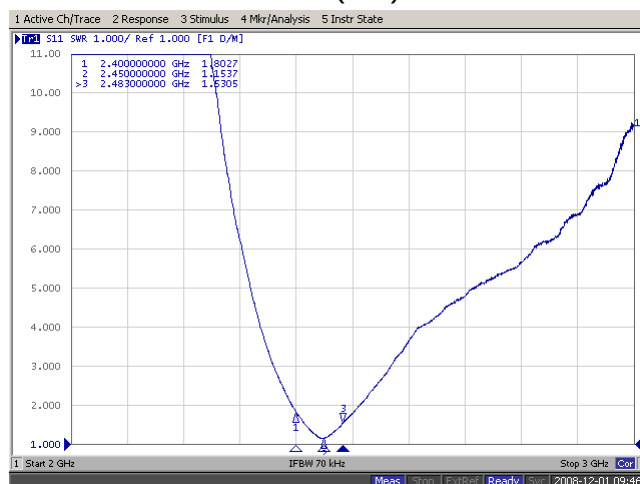
REV.
A

5-2. Return Loss & VSWR

Return Loss (S₁₁)



VSWR(S₁₁)



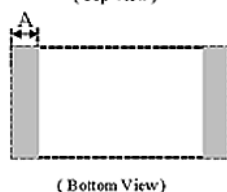
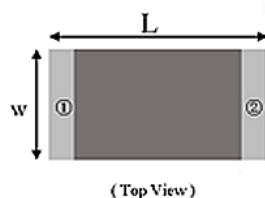
6. Antenna Dimensions (unit: mm)

a. Antenna Dimensions

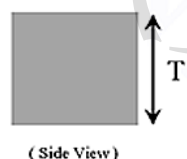
Applications

1. Bluetooth
2. Wireless LAN
3. ISM band 2.4GHz wireless applications

Dimensions (Unit: mm)



Number	Terminal Name
①	INPUT
②	NC



Symbols	L	W	T	A
Dimensions	1.60 ± 0.20	0.80 ± 0.20	0.5 ± 0.20	0.30 ± 0.10



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

**TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification**

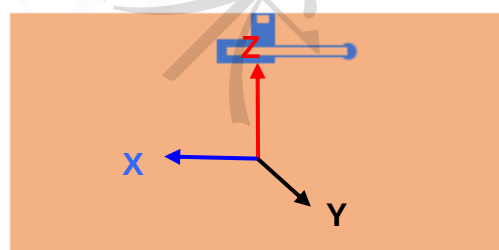
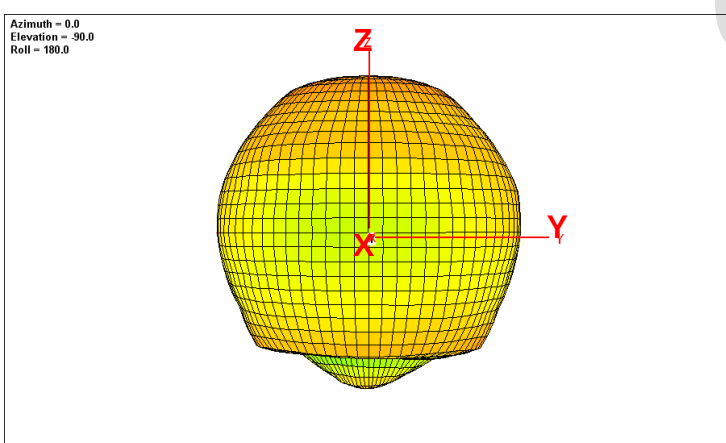
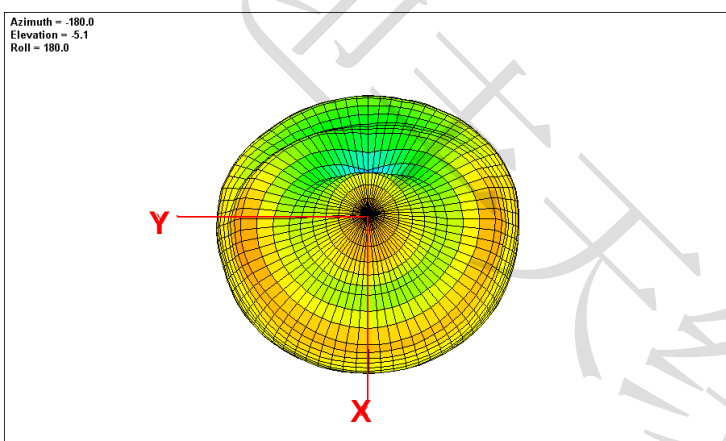
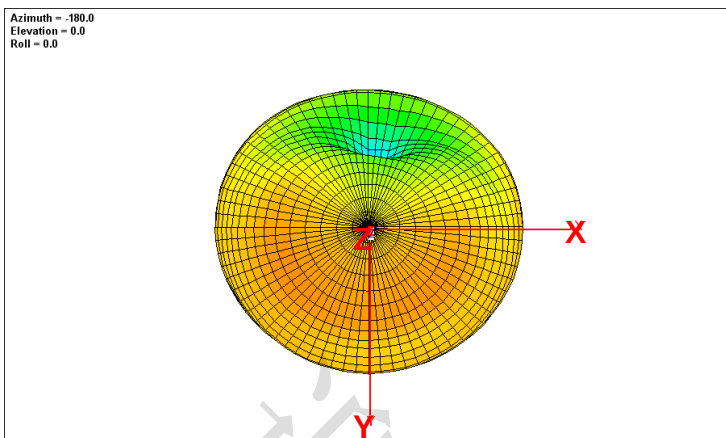
**DOCUMENT
NO.**

YF1608H1P2G45

**REV.
A**

7. Radiation Pattern (80 x 40 mm² ground plane)

7-1. 3D Gain Pattern @ 2442 MHz



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGYCO.,LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

**TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification**

**DOCUMENT
NO.**

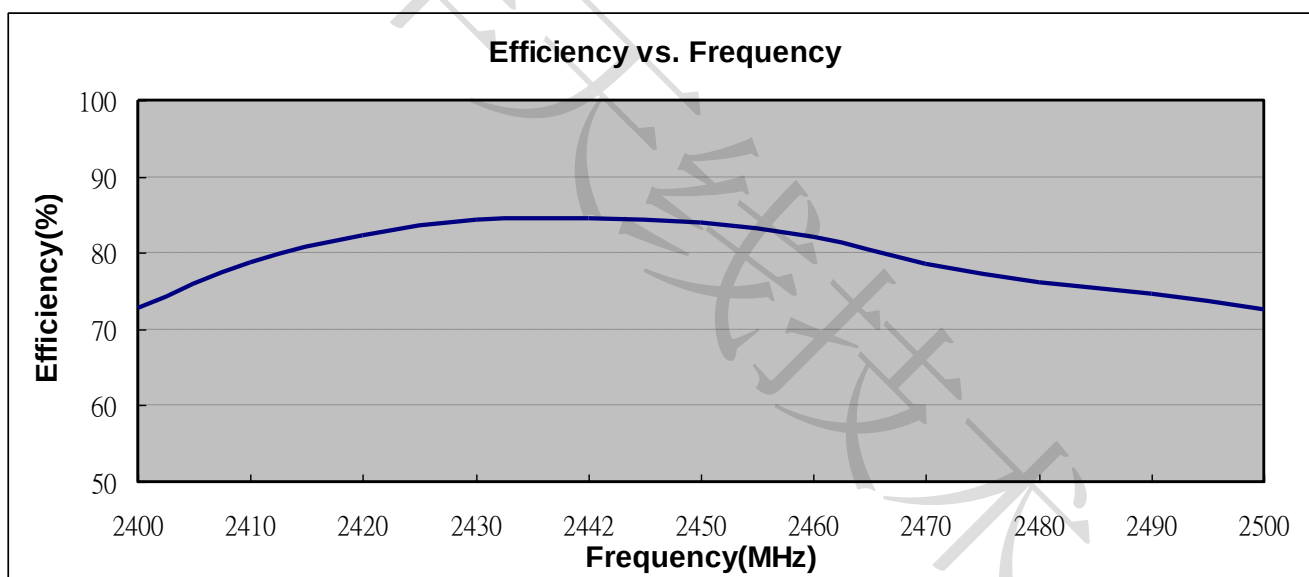
YF1608H1P2G45

**REV.
A**

7-2. 3D Efficiency Table

Frequency(MHz)	2400	2410	2420	2430	2442	2450	2460	2470	2480	2490	2500
Efficiency (dB)	-1.4	-1.0	-0.9	-0.7	-0.7	-0.8	-0.9	-1.1	-1.2	-1.3	-1.4
Efficiency (%)	62.8	63.7	64.3	64.4	65.5	65.0	64.0	63.6	63.1	62.6	61.5
Gain (dBi)	1.1	1.2	1.3	1.4	1.5	1.5	1.4	1.3	1.2	1.1	1.1

7-3. 3D Efficiency vs. Frequency



8. Layout Guide

a. Solder Land Pattern:

Land pattern for soldering (gray marking areas) is as shown below. Depending on



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

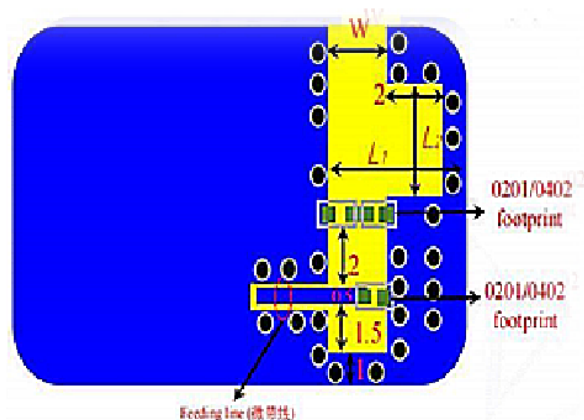
Approved by : MR.FANG

**TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification**

**DOCUMENT
NO.**

YF1608H1P2G45

**REV.
A**

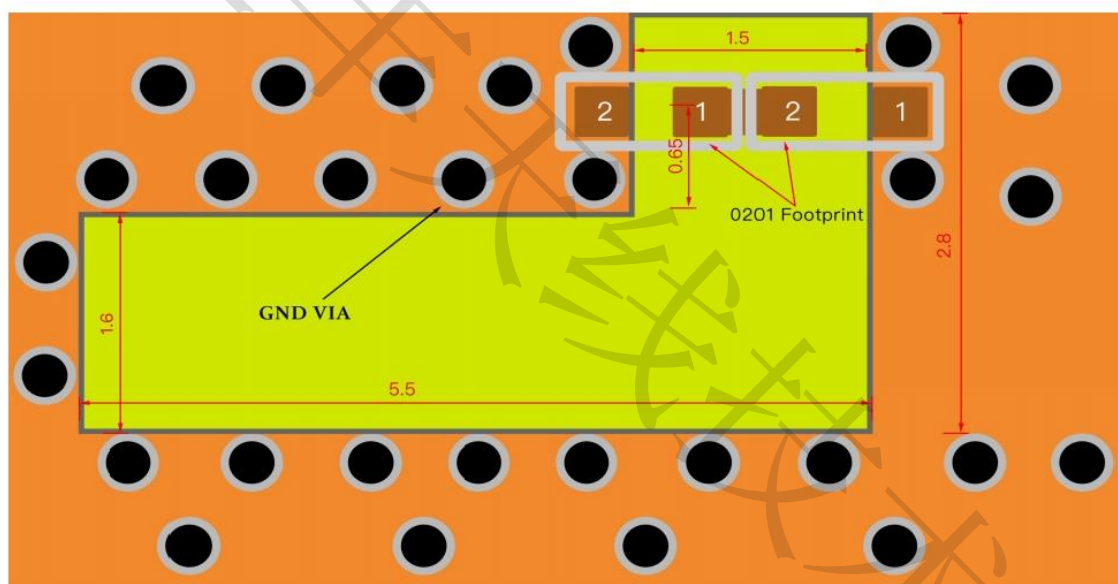
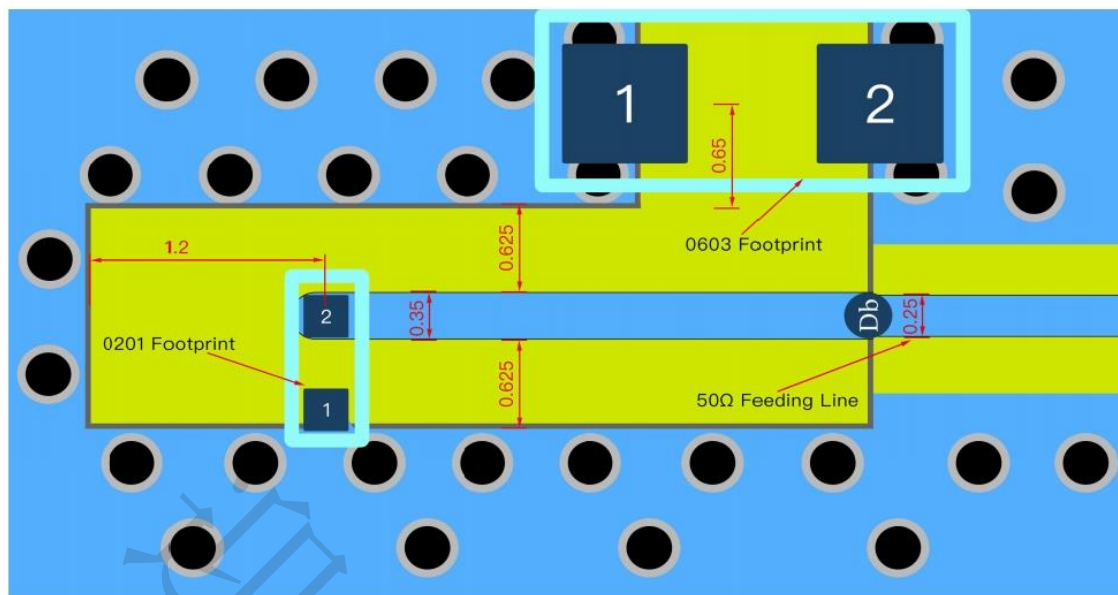


SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Approved by : **MR.FANG**

REV.
A

Evaluation Board and Matching Circuits



Bottom View

Unit : mm

c. Fine tuning element vs. Center frequency



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

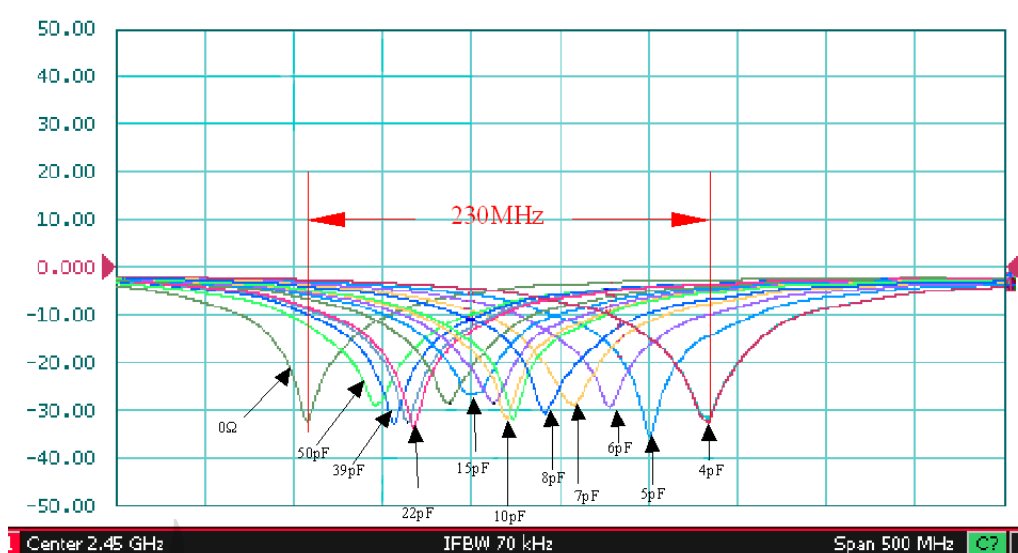
TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

DOCUMENT
NO.

YF1608H1P2G45

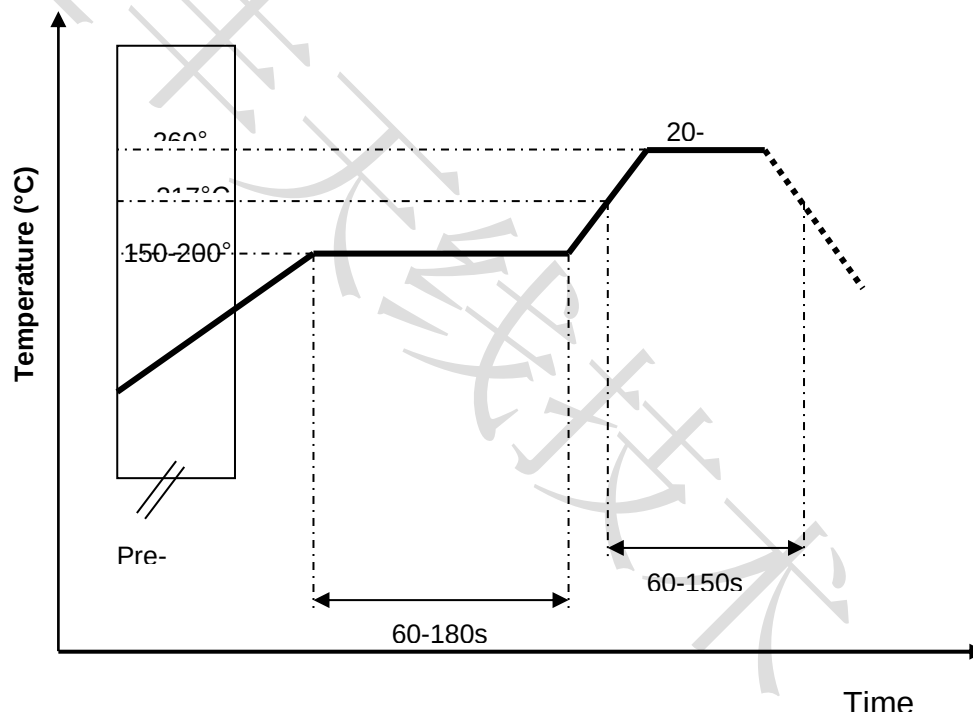
REV.
A

PAGE 7 OF 11



9. Soldering Conditions

a. Typical Soldering Profile for Lead-free Process



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

DOCUMENT
NO.

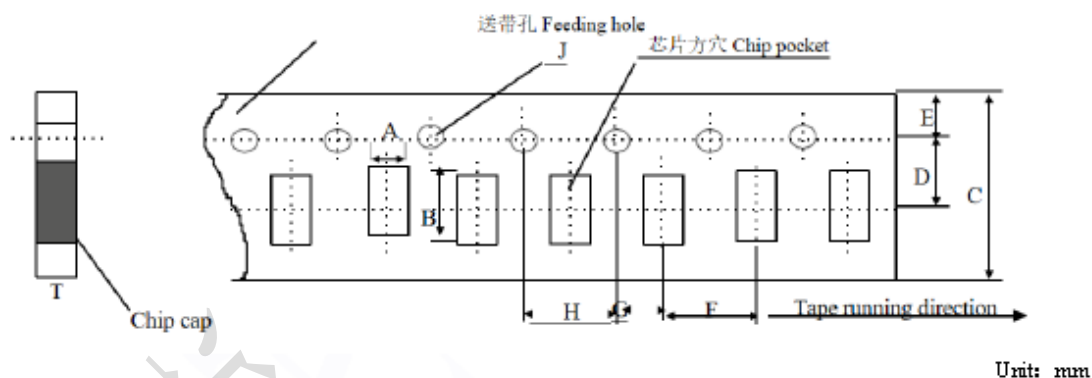
YF1608H1P2G45

REV.
A

Packing

- (1) Quantity/Reel: 5000 pcs/Reel
- (2) Plastic tape:

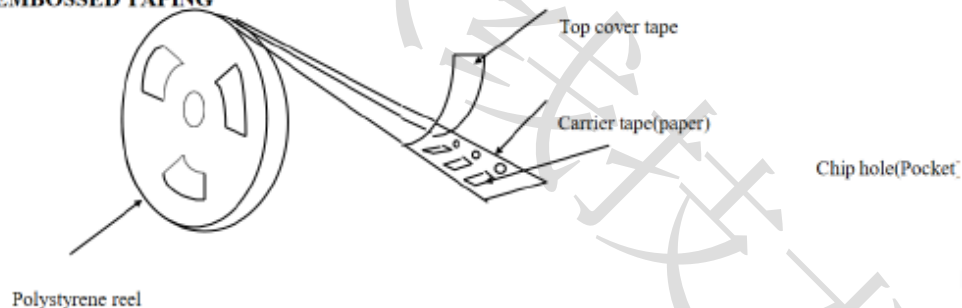
Dimensions of paper taping



代号 Code 纸带规格 papersize	A	B	C	D*	E	F	G*	H	J	T
尺寸	1.10 ±0.10	1.90 ±0.10	8.00 ±0.10	3.50 ±0.05	1.75 ±0.10	4.00 ±0.10	2.00 ±0.10	4.00 ±0.10	1.50 ±0.10	1.10 Max

Reel (4000 pcs/Reel)

EMBOSED TAPING



Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition).
Temperature: 5~40°C /Relative Humidity: 20~70%



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

DOCUMENT
NO.

YF1608H1P2G45

REV.
A

Reliability Table

Test Item	Procedure	Requirements Ceramic Type	Remark (Reference)
Electrical Characterization		Fulfill the electrical specification	User Spec.
Thermal Shock	1. Preconditioning: 50 ± 10°C / 1 hr, then keep for 24 ± 1 hrs at room temp. 2. Initial measure: Spec: refer Initial spec. 3. Rapid change of temperature test: -30°C to +85°C; 100 cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 107
Temperature Cycling	1. Initial measure: Spec: refer Initial spec. 2. 100 Cycles (-30°C to +85°C), Soak Mode=1 (2 Cycle/hours). 3. Measurement at 24 ± 2Hours after test condition.	No Visible Damage. Fulfill the electrical specification.	JESD22 JA104
High Temperature Exposure	1. Initial measure: Spec: refer Initial spec. 2. Unpowered; 500hours @ T=+85°C. 3. Measurement at 24 ± 2 hours after test.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Low Temperature Storage	1. Initial measure: Spec: refer Initial spec. 2. Unpowered: 500hours @ T= -30°C. 3. Measurement at 24 ± 2 hours after test.	No Visible Damage. Fulfill the electrical specification.	MIL-STD-202 108
Solderability (SMD Bottom Side)	Dipping method: a. Temperature: 235 ± 5°C b. Dipping time: 3 ± 0.5s	The solder should cover over 95% of the critical area of bottom side.	IEC 60384-21/22 4.10
Soldering Heat Resistance (RSH)	Preheating temperature: 150 ± 10°C. Preheating time: 1~2 min. Solder temperature: 260 ± 5°C. Dipping time: 5 ± 0.5s	No Visible Damage.	IEC 60384-21/22 4.10



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGYCO.,LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

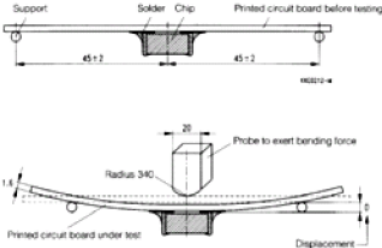
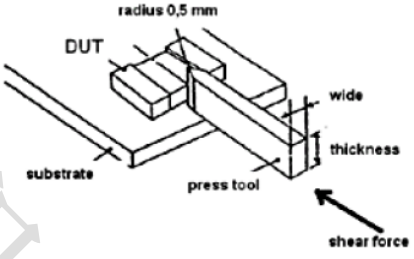
Approved by : MR.FANG

TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

DOCUMENT
NO.

YF1608H1P2G45

REV.
A

Board Flex (SMD)	1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm) 2. Apply the load in direction of the arrow until bending reaches 2 mm. 	No Visible Damage.	AEC-Q200 005
Adhesion	Force of 1.8Kg for 60 seconds. 	No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.	AEC-Q200 006
Physical Dimension	Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.	In accordance with specification.	JESD22 JB100



深圳市迎丰天线技术有限公司

SHEN ZHEN YINGFENG ANTENNA TECHNOLOGY CO., LTD

Prepared by : JIEXI

Designed by : Jason

Checked by : Jason

Approved by : MR.FANG

TITLE : 1.6x 0.8 x0.5(mm) WiFi/Bluetooth Ceramic Chip
Antenna (YF1608H1) Engineering Specification

DOCUMENT
NO.

YF1608H1P2G45

REV.
A